## 8-bit Microcontrollers

## CMOS

## F²MC-8FX MB95430H Series

## MB95F432H/F433H/F434H <br> MB95F432K/F433K/F434K

## DESCRIPTION

MB95430H is a series of general-purpose, single-chip microcontrollers. In addition to a compact instruction set, the microcontrollers of this series contain a variety of peripheral resources.
Note: $\mathrm{F}^{2} \mathrm{MC}$ is the abbreviation of FUJITSU Flexible Microcontroller.

## FEATURES

- F²MC-8FX CPU core

Instruction set optimized for controllers

- Multiplication and division instructions
- 16-bit arithmetic operations
- Bit test branch instructions
- Bit manipulation instructions, etc.
- Clock
- Selectable main clock source

Main OSC clock (up to 16.25 MHz , maximum machine clock frequency: 8.125 MHz )
External clock (up to 32.5 MHz , maximum machine clock frequency: 16.25 MHz )
Main CR clock ( $1 / 8 / 10 / 12.5 \mathrm{MHz} \pm 2 \%$, maximum machine clock frequency: 12.5 MHz )

- Selectable subclock source

Sub-OSC clock ( 32.768 kHz )
External clock ( 32.768 kHz )
Sub-CR clock (Typ: 100 kHz, Min: 50 kHz, Max: 200 kHz)

- Timer
- 8/16-bit composite timer $\times 1$ channel
- 16 -bit PPG $\times 1$ channel
- 16-bit free-running timer $\times 1$ channel
- 16-bit output compare $\times 2$ channels
- Time-base timer $\times 1$ channel
- Watch prescaler $\times 1$ channel
- UART/SIO $\times 1$ channel
- Full duplex double buffer
- Capable of clock-asynchronous (UART) serial data transfer and clock-synchronous (SIO) serial data transfer
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For the information for microcontroller supports, see the following website.
http://edevice.fujitsu.com/micom/en-support/
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- ${ }^{2} \mathrm{C} \times 1$ channel
- Built-in wake-up function
- Voltage comparator $\times 4$ channels
- Operational amplifier (OPAMP) $\times 1$ channel
- Software-select programmable gain
- Software-select standalone option
- Power down function included
- External interrupt $\times 8$ channels
- Interrupt by edge detection (rising edge, falling edge, and both edges can be selected)
- Can be used to wake up the device from different low power consumption (standby) modes
- 8/10-bit A/D converter $\times 17$ channels
- 8-bit and 10-bit resolution can be chosen.
- Low power consumption (standby) modes
- Stop mode
- Sleep mode
- Watch mode
- Time-base timer mode
- I/O port
- MB95F432H/F433H/F434H (maximum no. of I/O ports: 28)

General-purpose I/O ports (N-ch open drain) : 1
General-purpose I/O ports (CMOS I/O) : 27

- MB95F432K/F433K/F434K (maximum no. of I/O ports: 29)

General-purpose I/O ports (N-ch open drain) : 2
General-purpose I/O ports (CMOS I/O) : 27

- On-chip debug
- 1-wire serial control
- Serial writing supported (asynchronous mode)
- Hardware/software watchdog timer
- Built-in hardware watchdog timer
- Built-in software watchdog timer
- Low-voltage detection reset circuit
- Built-in low-voltage detector
- Clock supervisor counter
- Built-in clock supervisor counter function
- Programmable port input voltage level
- CMOS input level / hysteresis input level
- Dual operation Flash memory
- The erase/write operation and the read operation can be executed in different banks (upper bank/lower bank) simultaneously.
- Flash memory security function
- Protects the content of the Flash memory

■ PRODUCT LINE-UP

|  | MB95F432H | MB95F433H | MB95F434H | MB95F432K | MB95F433K | MB95F434K |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Type | Flash memory product |  |  |  |  |  |
| Clock supervisor counter | It supervises the main clock oscillation. |  |  |  |  |  |
| Program ROM capacity | 8 Kbyte | 12 Kbyte | 20 Kbyte | 8 Kbyte | 12 Kbyte | 20 Kbyte |
| RAM capacity | 240 bytes | 240 bytes | 496 bytes | 240 bytes | 240 bytes | 496 bytes |
| Low-voltage detection reset | No |  |  | Yes |  |  |
| Reset input | Dedicated |  |  | Selected by software |  |  |
| CPU functions | Number of basic instructions $: 136$ <br> Instruction bit length $: 8$ bits <br> Instruction length $: 1$ to 3 bytes <br> Data bit length $: 1,8$ and 16 bits <br> Minimum instruction execution time $: 61.5 \mathrm{~ns}$ (with machine clock $=16.25 \mathrm{MHz}$ ) <br> Interrupt processing time $: 0.6 \mu \mathrm{~s}$ (with machine clock $=16.25 \mathrm{MHz}$ ) |  |  |  |  |  |
| Generalpurpose I/O | I/O ports (Max): 28 CMOS I/O: 27 <br> N -ch open drain: 1 |  |  | I/O ports (Max): 29 CMOS I/O: 27 <br> N-ch open drain: 2 |  |  |
| Time-base timer | Interrupt cycle: 0.256 ms to 8.3 s (when external clock $=4 \mathrm{MHz}$ ) |  |  |  |  |  |
| Hardware/ software watchdog timer | Reset generation cycle <br> - Main oscillation clock at $10 \mathrm{MHz}: 105 \mathrm{~ms}$ (Min) <br> The sub-CR clock can be used as the source clock of the hardware watchdog timer. |  |  |  |  |  |
| Wild register | It can be used to replace three bytes of data. |  |  |  |  |  |
| 8/10-bit A/D | 17 channels (Ch. 16 is the channel for OPAMP output.) |  |  |  |  |  |
| converter | 8 -bit resolution and 10-bit resolution can be chosen. |  |  |  |  |  |
| 8/16-bit composite timer | 1 channel |  |  |  |  |  |
|  | The timer can be configured as an " 8 -bit timer $\times 2$ channels" or a "16-bit timer $\times 1$ channel". It has built-in timer function, PWC function, PWM function and input capture function. Count clock: it can be selected from internal clocks (seven types) and external clocks. It can output square wave. |  |  |  |  |  |
| External interrupt | 8 channels |  |  |  |  |  |
|  | Interrupt by edge detection (The rising edge, falling edge, or both edges can be selected.) It can be used to wake up the device from different standby modes. |  |  |  |  |  |
| On-chip debug | 1-wire serial control It supports serial writing. (asynchronous mode) |  |  |  |  |  |
|  | 1 channel |  |  |  |  |  |
| UART/SIO | Data transfer with UART/SIO is enabled. <br> It has a full duplex double buffer, variable data length (5/6/7/8 bits), a built-in baud rate generator and an error detection function. <br> It uses the NRZ type transfer format. <br> LSB-first data transfer and MSB-first data transfer are available to use. <br> Clock-asynchronous (UART) serial data transfer and clock-synchronous (SIO) serial data transfer is enabled. |  |  |  |  |  |

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| Part number <br> Parameter | MB95F432H | MB95F433H | MB95F434H | MB95F432K | MB95F433K | MB95F434K |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 1 channel |  |  |  |  |  |
| ${ }^{12} \mathrm{C}$ | Master/slave transmission and receiving It has a bus error function, an arbitration function, a transmission direction detection function and a wake-up function. <br> It also has functions of generating and detecting repeated START conditions. |  |  |  |  |  |
| 16-bit PPG | PWM mode and single-shot mode are available to use. Ch. 0 can work with the multi-functional timer or individually. |  |  |  |  |  |
| $\begin{aligned} & \hline \text { Output } \\ & \text { compare } \\ & \hline \end{aligned}$ | 1 channel of 16 -bit free-running timer with a compare buffer 2 channels of 16 -bit output compare |  |  |  |  |  |
| Voltage comparator | 4 channels |  |  |  |  |  |
| OPAMP | This is an operational amplifier used in an induction heater. It contains 7 software (registers) select close loop gain selections for ground current sensing according to different sense resistor values. The OPAMP can also work as a standalone OPAMP. <br> It selects closed loop gain for ground current sensing according to different sense resistor values of a standalone OPAMP. |  |  |  |  |  |
| Watch prescaler | Eight different time intervals can be selected. |  |  |  |  |  |
| Flash memory | It supports automatic programming, Embedded Algorithm, and write/erase/erase-suspend/ erase-resume commands. <br> It has a flag indicating the completion of the operation of Embedded Algorithm. <br> Number of write/erase cycles: 100000 <br> Data retention time: 20 years <br> Flash security feature for protecting the content of the Flash memory |  |  |  |  |  |
| Standby mode | Sleep mode, stop mode, watch mode, time-base timer mode |  |  |  |  |  |
| Package | $\begin{aligned} & \hline \text { FPT-32P-M30 } \\ & \text { DIP-32P-M06 } \end{aligned}$ |  |  |  |  |  |

## PACKAGES AND CORRESPONDING PRODUCTS

| Part number | MB95F432H | MB95F433H | MB95F434H | MB95F432K | MB95F433K | MB95F434K |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Package |  |  |  |  |  |  |
| FPT-32P-M30 | O | O | O | O | O | O |
| DIP-32P-M06 | O | O | O | O | O | 0 |

O: Available

## DIFFERENCES AMONG PRODUCTS AND NOTES ON PRODUCT SELECTION

－Current consumption
When using the on－chip debug function，take account of the current consumption of flash erase／write．
For details of current consumption，see＂■ ELECTRICAL CHARACTERISTICS＂．
－Package
For details of information on each package，see＂⿴囗十⿴囗十⿱一⿴⿻儿口一 PACKAGES AND CORRESPONDING PRODUCTS＂and ＂■ PACKAGE DIMENSIONS＂．
－Operating voltage
The operating voltage varies，depending on whether the on－chip debug function is used or not．
For details of the operating voltage，see＂■ ELECTRICAL CHARACTERISTICS＂．
－On－chip debug function
The on－chip debug function requires that $\mathrm{V}_{\mathrm{cc}}$ ， $\mathrm{V}_{\text {ss }}$ and one serial wire be connected to an evaluation tool．

## PIN ASSIGNMENT




PIN DESCRIPTION

| Pin no. |  | Pin name | I/O circuit type*3 | Function |
| :---: | :---: | :---: | :---: | :---: |
| LQFP32*1 | SH-DIP32*2 |  |  |  |
| 1 | 5 | PG2 | C | General-purpose I/O port |
|  |  | PPG |  | 16-bit PPG output pin |
|  |  | X1A |  | Subclock I/O oscillation pin |
|  |  | OUT1 |  | Output compare ch. 1 output pin |
| 2 | 6 | PG1 | C | General-purpose I/O port |
|  |  | TRG |  | 16-bit PPG trigger input pin |
|  |  | ADTG |  | A/D converter trigger input pin |
|  |  | X0A |  | Subclock I/O oscillation pin |
|  |  | BZ |  | Buzzer output pin |
|  |  | OUTO |  | Output compare ch. 0 output pin |
| 3 | 7 | Vcc | - | Power supply pin |
| 4 | 8 | C | - | Capacitor connection pin |
| 5 | 9 | P60 | K | General-purpose I/O port |
|  |  | OPAMP_P |  | Operational amplifier input pin |
| 6 | 10 | P61 | K | General-purpose I/O port |
|  |  | OPAMP_N |  | Operational amplifier input pin |
| 7 | 11 | P62 | J | General-purpose I/O port |
|  |  | OPAMP_O |  | Operational amplifier output pin |
| 8 | 12 | P12 | H | General-purpose I/O port |
|  |  | EC0 |  | 8/16-bit composite timer external clock input pin |
|  |  | UI |  | UART/SIO data input pin |
|  |  | SCL |  | ${ }^{2} \mathrm{C}$ C clock I/O pin |
|  |  | DBG |  | DBG input pin |
| 9 | 13 | P00 | E | General-purpose I/O port |
|  |  | INT00 |  | External interrupt input pin |
|  |  | AN00 |  | A/D converter analog input pin |
| 10 | 14 | P01 | E | General-purpose I/O port |
|  |  | INT01 |  | External interrupt input pin |
|  |  | AN01 |  | A/D converter analog input pin |
|  |  | BZ |  | Buzzer output pin |
| 11 | 15 | P02 | E | General-purpose I/O port |
|  |  | INT02 |  | External interrupt input pin |
|  |  | AN02 |  | A/D converter analog input pin |
|  |  | UCK |  | UART/SIO clock I/O pin |

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| Pin no. |  | Pin name | I/O circuit type* | Function |
| :---: | :---: | :---: | :---: | :---: |
| LQFP32*1 | SH-DIP32*2 |  |  |  |
| 12 | 16 | P03 | F | General-purpose I/O port |
|  |  | INT03 |  | External interrupt input pin |
|  |  | AN03 |  | A/D converter analog input pin |
|  |  | UO |  | UART/SIO data output pin |
|  |  | SDA |  | $1^{2} \mathrm{C}$ data I/O pin |
| 13 | 17 | P04 | F | General-purpose I/O port |
|  |  | INT04 |  | External interrupt input pin |
|  |  | AN04 |  | A/D converter analog input pin |
|  |  | UI |  | UART/SIO data input pin |
|  |  | SCL |  | $1^{2} \mathrm{C}$ clock I/O pin |
| 14 | 18 | P05 | E | General-purpose I/O port |
|  |  | INT05 |  | External interrupt input pin |
|  |  | AN05 |  | A/D converter analog input pin |
|  |  | TOO |  | Timer output pin |
| 15 | 19 | P06 | E | General-purpose I/O port |
|  |  | INT06 |  | External interrupt input pin |
|  |  | AN06 |  | A/D converter analog input pin |
|  |  | TO1 |  | Timer output pin |
| 16 | 20 | P07 | E | General-purpose I/O port |
|  |  | INT07 |  | External interrupt input pin |
|  |  | AN07 |  | A/D converter analog input pin |
|  |  | EC0 |  | 8/16-bit composite timer external clock input pin |
| 17 | 21 | P70 | D | General-purpose I/O port |
|  |  | CMPO_O |  | Comparator ch. 0 output pin |
|  |  | OUTO |  | Output compare ch. 0 output pin |
|  |  | TRG |  | 16-bit PPG trigger input pin |
| 18 | 22 | P71 | 1 | General-purpose I/O port |
|  |  | CMPO_P |  | Comparator ch. 0 positive input pin |
|  |  | AN08 |  | A/D converter analog input pin |
| 19 | 23 | P72 | 1 | General-purpose I/O port |
|  |  | CMPO_N |  | Comparator ch. 0 negative input pin |
|  |  | AN09 |  | A/D converter analog input pin |
| 20 | 24 | P73 | D | General-purpose I/O port |
|  |  | CMP1_O |  | Comparator ch. 1 output pin |
|  |  | OUT1 |  | Output compare ch. 1 output pin |
|  |  | PPG |  | 16-bit PPG output pin |

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| Pin no. |  | Pin name | $\begin{aligned} & \text { c/rcuit } \\ & \text { type }{ }^{* 3} \end{aligned}$ | Function |
| :---: | :---: | :---: | :---: | :---: |
| LQFP32*1 | SH-DIP32*2 |  |  |  |
| 21 | 25 | P74 | 1 | General-purpose I/O port |
|  |  | CMP1_P |  | Comparator ch. 1 positive input pin |
|  |  | AN10 |  | A/D converter analog input pin |
| 22 | 26 | P75 | 1 | General-purpose I/O port |
|  |  | CMP1_N |  | Comparator ch. 1 negative input pin |
|  |  | AN11 |  | A/D converter analog input pin |
| 23 | 27 | P76 | D | General-purpose I/O port |
|  |  | CMP2_O |  | Comparator ch. 2 output pin |
|  |  | UCK |  | UART/SIO clock I/O pin |
| 24 | 28 | P63 | 1 | General-purpose I/O port |
|  |  | CMP2_P |  | Comparator ch. 2 positive input pin |
|  |  | AN12 |  | A/D converter analog input pin |
| 25 | 29 | P64 | 1 | General-purpose I/O port |
|  |  | CMP2_N |  | Comparator ch. 2 negative input pin |
|  |  | AN13 |  | A/D converter analog input pin |
| 26 | 30 | P65 | L | General-purpose I/O port |
|  |  | CMP3_O |  | Comparator ch. 3 output pin |
|  |  | UO |  | UART/SIO data output pin |
|  |  | SDA |  | ${ }^{12} \mathrm{C}$ data I/O pin |
| 27 | 31 | P66 | 1 | General-purpose I/O port |
|  |  | CMP3_P |  | Comparator ch. 3 positive input pin |
|  |  | AN14 |  | A/D converter analog input pin |
| 28 | 32 | P67 | 1 | General-purpose I/O port |
|  |  | CMP3_N |  | Comparator ch. 3 negative input pin |
|  |  | AN15 |  | A/D converter analog input pin |
| 29 | 1 | PF2 | A | General-purpose I/O port |
|  |  | $\overline{\mathrm{RST}}$ |  | Reset pin <br> Dedicated reset pin in MB95F432H/F433H/F434H |
| 30 | 2 | PFO | B | General-purpose I/O port |
|  |  | X0 |  | Main clock I/O oscillation pin |
| 31 | 3 | PF1 | B | General-purpose I/O port |
|  |  | X1 |  | Main clock I/O oscillation pin |
| 32 | 4 | Vss | - | Power supply pin (GND) |

*1: Package code: FPT-32P-M30
*2: Package code: DIP-32P-M06
*3: For the I/O circuit types, see "■ I/O CIRCUIT TYPE".

## I/O CIRCUIT TYPE

| Type | Circuit | Remarks |
| :---: | :---: | :---: |
| A |  | - N-ch open drain output <br> - Hysteresis input <br> - Reset output |
| B |  | - Oscillation circuit <br> - High-speed side Feedback resistance: approx. $1 \mathrm{M} \Omega$ <br> - CMOS output <br> - Hysteresis input |
| C |  | - Oscillation circuit <br> - Low-speed side Feedback resistance: approx. $10 \mathrm{M} \Omega$ <br> - CMOS output <br> - Hysteresis input <br> - Pull-up control available |

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| Type | Circuit | Remarks |
| :---: | :---: | :---: |
| D |  | - CMOS output <br> - Hysteresis input |
| E |  | - CMOS output <br> - Hysteresis input <br> - Pull-up control available <br> - Analog input |
| F |  | - CMOS output <br> - Hysteresis input <br> - CMOS input <br> - Pull-up control available <br> - Analog input <br> - N-ch open drain output (as $\mathrm{I}^{2} \mathrm{C}$ output) |
| G |  | - CMOS output <br> - Hysteresis input <br> - Pull-up control available |
| H |  | - N-ch open drain output <br> - Hysteresis input <br> - CMOS input |

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| Type | Circuit | Remarks |
| :---: | :---: | :---: |
| 1 |  | - CMOS output <br> - Hysteresis input |
| J |  | - CMOS output <br> - Hysteresis input |
| K |  | - CMOS output <br> - Hysteresis input |
| L |  | - CMOS output <br> - Hysteresis input <br> - CMOS input <br> - N-ch open drain output (as $\mathrm{I}^{2} \mathrm{C}$ output) |

## ■ NOTES ON DEVICE HANDLING

## - Preventing latch-ups

When using the device, ensure that the voltage applied does not exceed the maximum voltage rating.
In a CMOS IC, if a voltage higher than $V_{c c}$ or a voltage lower than $V_{s s}$ is applied to an input/output pin that is neither a medium-withstand voltage pin nor a high-withstand voltage pin, or if a voltage out of the rating range of power supply voltage mentioned in "1. Absolute Maximum Ratings" of "■ ELECTRICAL CHARACTERISTICS" is applied to the Vcc pin or the Vss pin, a latch-up may occur.
When a latch-up occurs, power supply current increases significantly, which may cause a component to be thermally destroyed.

- Stabilizing supply voltage

Supply voltage must be stabilized.
A malfunction may occur when power supply voltage fluctuates rapidly even though the fluctuation is within the guaranteed operating range of the Vcc power supply voltage.
As a rule of voltage stabilization, suppress voltage fluctuation so that the fluctuation in Vcc ripple (p-p value) at the commercial frequency $(50 \mathrm{~Hz} / 60 \mathrm{~Hz})$ does not exceed $10 \%$ of the standard $\mathrm{V} c \mathrm{c}$ value, and the transient fluctuation rate does not exceed $0.1 \mathrm{~V} / \mathrm{ms}$ at a momentary fluctuation such as switching the power supply.

- Notes on using the external clock

When an external clock is used, oscillation stabilization wait time is required for power-on reset, wake-up from subclock mode or stop mode.

## ■ PIN CONNECTION

- Treatment of unused pins

If an unused input pin is left unconnected, a component may be permanently damaged due to malfunctions or latch-ups. Always pull up or pull down an unused input pin through a resistor of at least $2 \mathrm{k} \Omega$. Set an unused input/output pin to the output state and leave it unconnected, or set it to the input state and treat it the same as an unused input pin. If there is an unused output pin, leave it unconnected.

- Power supply pins

To reduce unnecessary electro-magnetic emission, prevent malfunctions of strobe signals due to an increase in the ground level, and conform to the total output current standard, always connect the Vcc pin and the Vss pin to the power supply and ground outside the device. In addition, connect the current supply source to the Vcc pin and the Vss pin with low impedance.
It is also advisable to connect a ceramic capacitor of approximately $0.1 \mu \mathrm{~F}$ as a bypass capacitor between the $\mathrm{V}_{\mathrm{cc}}$ pin and the Vss pin at a location close to this device.

- DBG pin

Connect the DBG pin directly to an external pull-up resistor.
To prevent the device from unintentionally entering the debug mode due to noise, minimize the distance between the DBG pin and the $\mathrm{V}_{\mathrm{cc}}$ or $\mathrm{V}_{\mathrm{ss}}$ pin when designing the layout of the printed circuit board.
The DBG pin should not stay at "L" level after power-on until the reset output is released.

- $\overline{\text { RST }}$ pin

Connect the RST pin directly to an external pull-up resistor.
To prevent the device from unintentionally entering the reset mode due to noise, minimize the distance between the $\overline{\text { RST }}$ pin and the $\mathrm{V}_{\mathrm{cc}}$ or $\mathrm{V}_{\mathrm{ss}}$ pin when designing the layout of the printed circuit board.
The $\overline{R S T} / P F 2$ pin functions as the reset input/output pin after power-on. In addition, the reset output of the $\overline{\text { RST/PF2 pin can be enabled by the RSTOE bit in the SYSC1 register, and the reset input function and the }}$ general purpose I/O function can be selected by the RSTEN bit in the SYSC1 register.

- C pin

Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. The bypass capacitor for the Vcc pin must have a capacitance larger than Cs. For the connection to a smoothing capacitor Cs, see the diagram below. To prevent the device from unintentionally entering a mode to which the device is not set to transit due to noise, minimize the distance between the $C$ pin and $C$ s and the distance between C s and the $\mathrm{V}_{\text {ss }}$ pin when designing the layout of a printed circuit board.

- DBG/RST/C pins connection diagram



## BLOCK DIAGRAM



## CPU CORE

## - Memory Space

The memory space of the MB95430H Series is 64 Kbyte in size, and consists of an I/O area, a data area, and a program area. The memory space includes areas intended for specific purposes such as general-purpose registers and a vector table. The memory maps of the MB95430H Series are shown below.

- Memory Maps

- I/O MAP

| Address | Register abbreviation | Register name | R/W | Initial value |
| :---: | :---: | :---: | :---: | :---: |
| 0000н | PDR0 | Port 0 data register | R/W | 00000000в |
| 0001н | DDR0 | Port 0 direction register | R/W | 00000000в |
| 0002н | PDR1 | Port 1 data register | R/W | 00000000в |
| 0003н | DDR1 | Port 1 direction register | R/W | 00000000в |
| 0004н | - | (Disabled) | - | - |
| 0005н | WATR | Oscillation stabilization wait time setting register | R/W | 11111111в |
| 0006н | - | (Disabled) | - | - |
| 0007н | SYCC | System clock control register | R/W | 0000X011в |
| 0008н | STBC | Standby control register | R/W | 00000XXX |
| 0009н | RSRR | Reset source register | R/W | ХХХХХХХХв |
| 000Ан | TBTC | Time-base timer control register | R/W | 00000000в |
| 000Bн | WPCR | Watch prescaler control register | R/W | 00000000в |
| 000C ${ }_{\text {H }}$ | WDTC | Watchdog timer control register | R/W | 00XX0000в |
| 000D ${ }_{\text {н }}$ | SYCC2 | System clock control register 2 | R/W | XX100011в |
| 000Ен to 0015 | - | (Disabled) | - | - |
| 0016н | PDR6 | Port 6 data register | R/W | 00000000в |
| 0017 ${ }_{\text {H }}$ | DDR6 | Port 6 direction register | R/W | 00000000в |
| 0018н | PDR7 | Port 7 data register | R/W | 00000000в |
| 0019н | DDR7 | Port 7 direction register | R/W | 00000000в |
| $\begin{aligned} & \text { 0020н } \\ & \text { to } \\ & 0027 \mathrm{H} \end{aligned}$ | - | (Disabled) | - | - |
| 0028H | PDRF | Port F data register | R/W | 00000000в |
| 0029н | DDRF | Port F direction register | R/W | 00000000в |
| 002Ан | PDRG | Port G data register | R/W | 00000000в |
| 002Вн | DDRG | Port G direction register | R/W | 00000000в |
| 002C ${ }_{\text {H }}$ | PUL0 | Port 0 pull-up register | R/W | 00000000в |
| $\begin{aligned} & \text { 002Dн } \\ & \text { to } \\ & 0034 \text { н } \end{aligned}$ | - | (Disabled) | - | - |
| 0035 ${ }^{\text {H }}$ | PULG | Port G pull-up register | R/W | 00000000в |
| 0036 ${ }^{\text {¢ }}$ | T01CR1 | 8/16-bit composite timer 01 status control register 1 ch. 0 | R/W | 00000000в |
| 0037 ${ }^{\text {H }}$ | T00CR1 | 8/16-bit composite timer 00 status control register 1 ch .0 | R/W | 00000000в |
| 0038н | BUZZ | Buzzer control register | R/W | 00000000в |
| 0039н | - | (Disabled) | - | - |

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| Address | Register abbreviation | Register name | R/W | Initial value |
| :---: | :---: | :---: | :---: | :---: |
| 003Ан | CMR0 | Voltage comparator control register ch. 0 | R/W | 000X0001в |
| 003Вн | CMR1 | Voltage comparator control register ch. 1 | R/W | 000X0001в |
| 003C | CMR2 | Voltage comparator control register ch. 2 | R/W | 000X0001в |
| 003D | CMR3 | Voltage comparator control register ch. 3 | R/W | 000X0001в |
| 003Ен | OPCR | OPAMP control register | R/W | 00000011в |
| 003FH to 0041н | - | (Disabled) | - | - |
| 0042н | PCNTH0 | 16-bit PPG status control register upper ch. 0 | R/W | 00000000в |
| 0043н | PCNTLO | 16-bit PPG status control register lower ch. 0 | R/W | 00000000в |
| 0044н | PTGS0 | 16-bit PPG trigger source control register ch. 0 | R/W | 00000000в |
| 0045 ${ }^{\text {H }}$ | - | (Disabled) | - | - |
| 0046н | OCUOC | 16-bit output compare stop trigger control register | R/W | 00000000в |
| 0047H | - | (Disabled) | - | - |
| 0048н | EIC00 | External interrupt circuit control register ch. 0/ch. 1 | R/W | 00000000в |
| 0049н | EIC10 | External interrupt circuit control register ch. 2/ch. 3 | R/W | 00000000в |
| 004Ан | EIC20 | External interrupt circuit control register ch. 4/ch. 5 | R/W | 00000000в |
| 004Вн | EIC30 | External interrupt circuit control register ch. 6/ch. 7 | R/W | 00000000в |
| $\begin{aligned} & \text { 004Cн, } \\ & 004 \mathrm{D} \end{aligned}$ | - | (Disabled) | - | - |
| 004Eн | SYSC2 | System control register 2 | R/W | 00000000в |
| 004FH | - | (Disabled) | - | - |
| 0050н | IBCR00 | ${ }^{2} \mathrm{C}$ bus control register 0 | R/W | 00000000в |
| 0051н | IBCR10 | $I^{2} \mathrm{C}$ bus control register 1 | R/W | 00000000в |
| 0052н | IBSR0 | $1^{2} \mathrm{C}$ bus status register | R/W | 00000000в |
| 0053н | IDDR0 | ${ }^{2} \mathrm{C}$ data register | R/W | 00000000в |
| 0054н | IAAR0 | ${ }^{12} \mathrm{C}$ address register | R/W | 00000000в |
| 0055 ${ }^{\text {¢ }}$ | ICCR0 | $1^{2} \mathrm{C}$ clock control register | R/W | 00000000в |
| 0056н | SMC10 | UART/SIO serial mode control register 1 ch .0 | R/W | 00000000в |
| 0057 ${ }_{\text {H }}$ | SMC20 | UART/SIO serial mode control register 2 ch .0 | R/W | 00100000в |
| 0058H | SSR0 | UART/SIO serial status and data register ch. 0 | R/W | 00000001в |
| 0059н | TDR0 | UART/SIO serial output data register ch. 0 | R/W | 00000000в |
| 005Ан | RDR0 | UART/SIO serial input data register ch. 0 | R | 00000000в |
| 005Вн | - | (Disabled) | - | - |
| 005CH | TCDTH | 16-bit free-running timer data register (upper) | R/W | 00000000в |
| 005D | TCDTL | 16-bit free-running timer data register (lower) | R/W | 00000000в |
| 005Eн | CPCLRH | 16-bit free-running timer compare clear register (upper) | R | 11111111в |
| 005F\% | CPCLRL | 16-bit free-running timer compare clear register (lower) | R | 11111111в |

(Continued)

| Address | Register abbreviation | Register name | R/W | Initial value |
| :---: | :---: | :---: | :---: | :---: |
| 0060н | TCCSH | 16-bit free-running timer control status register (upper) | R/W | 01000000в |
| 0061н | TCCSL | 16-bit free-running timer control status register (lower) | R/W | 00000000в |
| 0062н | ETCCSH | 16-bit free-running timer extended control status register (upper) | R/W | 00000000в |
| 0063H | ETCCSL | 16-bit free-running timer extended control status register (lower) | R/W | 00000000в |
| 0064н | OCCPOH | 16-bit output compare channel 0 register (upper) | R | 00000000в |
| 0065 ${ }^{\text {H }}$ | OCCPOL | 16-bit output compare channel 0 register (lower) | R | 00000000в |
| 0066н | OCCP1H | 16-bit output compare channel 1 register (upper) | R | 00000000в |
| 0067 ${ }^{\text {H }}$ | OCCP1L | 16-bit output compare channel 1 register (lower) | R | 00000000в |
| 0068н | OCSH | 16-bit output compare control status register (upper) | R/W | 00000000в |
| 0069н | OCSL | 16-bit output compare control status register (lower) | R/W | 00000000в |
| 006Ан | OCMCR | 16-bit output compare mode control register | R/W | 00000000в |
| 006В ${ }_{\text {н }}$ | EOCS | 16-bit output compare extended control status register | R/W | 00000000в |
| 006C ${ }_{\text {H }}$ | ADC1 | 8/10-bit A/D converter control register 1 | R/W | 00000000в |
| 006D | ADC2 | 8/10-bit A/D converter control register 2 | R/W | 00000000в |
| 006Eн | ADDH | 8/10-bit A/D converter data register (upper) | R/W | 00000000в |
| 006FH | ADDL | 8/10-bit A/D converter data register (lower) | R/W | 00000000в |
| 0070 ${ }^{\text {H }}$ | - | (Disabled) | - | - |
| 0071н | FSR2 | Flash memory status register 2 | R/W | 00000000в |
| 0072н | FSR | Flash memory status register | R/W | 000X0000в |
| 0073 ${ }^{\text {¢ }}$ | SWRE0 | Flash memory sector write control register 0 | R/W | 00000000в |
| 0074 ${ }_{\text {H }}$ | FSR3 | Flash memory status register 3 | R | 0000XXXX ${ }_{\text {в }}$ |
| 0075 ${ }^{\text {H }}$ | - | (Disabled) | - | - |
| 0076 | WREN | Wild register address compare enable register | R/W | 00000000в |
| 0077 ${ }_{\text {H }}$ | WROR | Wild register data test setting register | R/W | 00000000в |
| 0078н | - | (Disabled) | - | - |
| 0079н | ILR0 | Interrupt level setting register 0 | R/W | 11111111в |
| 007Ан | ILR1 | Interrupt level setting register 1 | R/W | 11111111в |
| 007Вн | ILR2 | Interrupt level setting register 2 | R/W | 11111111в |
| 007CH | ILR3 | Interrupt level setting register 3 | R/W | 11111111в |
| 007D | ILR4 | Interrupt level setting register 4 | R/W | 11111111в |
| 007Eн | ILR5 | Interrupt level setting register 5 | R/W | 11111111в |
| $\begin{aligned} & 007 \mathrm{~F}_{\mathrm{H}} \\ & \text { to } \\ & 0 \mathrm{~F} 7 \mathrm{~F}_{\mathrm{H}} \end{aligned}$ | - | (Disabled) | - | - |

(Continued)

| Address | Register abbreviation | Register name | R/W | Initial value |
| :---: | :---: | :---: | :---: | :---: |
| 0F80н | WRARH0 | Wild register address setting register (upper) ch. 0 | R/W | 00000000в |
| 0F81н | WRARLO | Wild register address setting register (lower) ch. 0 | R/W | 00000000в |
| 0F82н | WRDR0 | Wild register data setting register ch. 0 | R/W | 00000000в |
| 0F83н | WRARH1 | Wild register address setting register (upper) ch. 1 | R/W | 00000000в |
| 0F84н | WRARL1 | Wild register address setting register (lower) ch. 1 | R/W | 00000000в |
| 0F85 | WRDR1 | Wild register data setting register ch. 1 | R/W | 00000000в |
| 0F86н | WRARH2 | Wild register address setting register (upper) ch. 2 | R/W | 00000000в |
| 0F87н | WRARL2 | Wild register address setting register (lower) ch. 2 | R/W | 00000000в |
| 0F88н | WRDR2 | Wild register data setting register ch. 2 | R/W | 00000000в |
| 0F89н | WRARH3 | Wild register address setting register (upper) ch. 3 | R/W | 00000000в |
| 0F8Ан | WRARL3 | Wild register address setting register (lower) ch. 3 | R/W | 00000000в |
| 0F8Bн | WRDR3 | Wild register data setting register ch. 3 | R/W | 00000000в |
| $\begin{aligned} & \text { 0F8CH } \\ & \text { to } \\ & \text { 0F91 } \end{aligned}$ | - | (Disabled) | - | - |
| 0F92н | T01CR0 | 8/16-bit composite timer 01 status control register 0 ch. 0 | R/W | 00000000в |
| 0F93 ${ }_{\text {¢ }}$ | T00CR0 | 8/16-bit composite timer 00 status control register 0 ch. 0 | R/W | 00000000в |
| 0F94н | T01DR | 8/16-bit composite timer 01 data register ch. 0 | R/W | 00000000в |
| 0F95 ${ }^{\text {¢ }}$ | T00DR | 8/16-bit composite timer 00 data register ch. 0 | R/W | 00000000в |
| 0F96 | TMCRO | 8/16-bit composite timer 00/01 timer mode control register ch. 0 | R/W | 00000000в |
| $\begin{aligned} & \text { 0F97н } \\ & \text { to } \\ & \text { OFA9н } \end{aligned}$ | - | (Disabled) | - | - |
| ОFААн | PDCRH0 | 16-bit PPG down counter register (upper) ch. 0 | R/W | 00000000в |
| 0FABн | PDCRLO | 16-bit PPG down counter register (lower) ch. 0 | R/W | 00000000в |
| 0FACH | PCSRH0 | 16-bit PPG cycle setting buffer register (upper) ch. 0 | R/W | 11111111в |
| 0FAD | PCSRLO | 16-bit PPG cycle setting buffer register (lower) ch. 0 | R/W | 11111111в |
| 0FAEн | PDUTH0 | 16-bit PPG duty setting buffer register (upper) ch. 0 | R/W | 11111111в |
| 0FAFH | PDUTLO | 16-bit PPG duty setting buffer register (lower) ch. 0 | R/W | 11111111в |
|  | - | (Disabled) | - | - |
| 0FBEн | PSSR0 | UART/SIO prescaler select register ch. 0 | R/W | 00000000в |
| 0FBFн | BRSR0 | UART/SIO baud rate setting register ch. 0 | R/W | 00000000в |
| $\begin{aligned} & \text { 0FCOH, } \\ & \text { OFC1н } \end{aligned}$ | - | (Disabled) | - | - |
| 0FC2н | AIDRH | A/D input disable register (upper) | R/W | 00000000в |
| 0FC3н | AIDRL | A/D input disable register (lower) | R/W | 00000000в |
| $\begin{aligned} & \text { OFC4н } \\ & \text { to } \\ & \text { OFE3н } \end{aligned}$ | - | (Disabled) | - | - |

(Continued)
(Continued)

| Address | Register abbreviation | Register name | R/W | Initial value |
| :---: | :---: | :---: | :---: | :---: |
| OFE4н | CRTH | Main CR clock trimming register (upper) | R/W | 0XXXXXXX |
| OFE5 | CRTL | Main CR clock trimming register (lower) | R/W | 00XXXXXXв |
| 0FE6н, 0FE7H | - | (Disabled) | - | - |
| 0FE8н | SYSC1 | System configuration register 1 | R/W | 11000011в |
| 0FE9н | CMCR | Clock monitoring control register | R/W | 00000000в |
| 0FEAн | CMDR | Clock monitoring data register | R | 00000000в |
| 0FEBн | WDTH | Watchdog timer selection ID register (upper) | R | ХХХХХХХХв |
| 0FECн | WDTL | Watchdog timer selection ID register (lower) | R | ХХХХХХХХв |
| 0FED | - | (Disabled) | - | - |
| 0FEEн | ILSR | Input level select register | R/W | 00000000в |
| 0FEFH | WICR | Interrupt pin control register | R/W | 01000000в |
| $\begin{aligned} & \text { OFFOH } \\ & \text { to } \\ & \text { OFFFH }_{H} \end{aligned}$ | - | (Disabled) | - | - |

- R/W access symbols

R/W : Readable / Writable
R : Read only
W : Write only

- Initial value symbols

0 : The initial value of this bit is " 0 ".
1 : The initial value of this bit is " 1 ".
$\mathrm{X} \quad$ : The initial value of this bit is indeterminate.

Note: Do not write to an address that is "(Disabled)". If a "(Disabled)" address is read, an indeterminate value is returned.

## INTERRUPT SOURCE TABLE

| Interrupt source | Interrupt request number | Vector table address |  | Bit name of interrupt level setting register | Priority order of interrupt sources of the same level (occurring simultaneously) |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Upper | Lower |  |  |
| External interrupt ch. 0 |  |  |  |  | High |
| External interrupt ch. 4 |  |  |  |  | - |
| External interrupt ch. 1 | IRQ01 | FFF8 | FFF |  |  |
| External interrupt ch. 5 | IRQ01 | FF\% | FF' |  |  |
| External interrupt ch. 2 | IRQ02 | FFF6 | FFF7 ${ }^{\text {H }}$ | L0 |  |
| External interrupt ch. 6 |  |  | FF\% | L02 [1.0] |  |
| External interrupt ch. 3 |  | FF | FF |  |  |
| External interrupt ch. 7 | IRQ03 | F | FF |  |  |
| UART/SIO | IRQ04 | FFF2н | FFF3H | L04 [1:0] |  |
| 8/16-bit composite timer ch. 0 (lower) | IRQ05 | FFFOH | FFF1H | L05 [1:0] |  |
| 8/16-bit composite timer ch. 0 (upper) | IRQ06 | FFEE | FFEF ${ }_{\text {H }}$ | L06 [1:0] |  |
| Output compare ch. 0 match | IRQ07 | FFEC ${ }_{\text {¢ }}$ | FFED ${ }_{\text {н }}$ | L07 [1:0] |  |
| Output compare ch. 1 match | IRQ08 | FFEAн | FFEB | L08 [1:0] |  |
| - | IRQ09 | FFE8н | FFE9 ${ }_{\text {н }}$ | L09 [1:0] |  |
| Voltage comparator ch. 0 | IRQ10 | FFE6 ${ }_{\text {¢ }}$ | FFE7 ${ }_{\text {¢ }}$ | L10 [1:0] |  |
| Voltage comparator ch. 1 | IRQ11 | FFE4 ${ }_{\text {¢ }}$ | FFE5 | L11 [1:0] |  |
| Voltage comparator ch. 2 | IRQ12 | FFE2н | FFE3н | L12 [1:0] |  |
| Voltage comparator ch. 3 | IRQ13 | FFEOH | FFE1н | L13 [1:0] |  |
| 16-bit free-running timer (compare match/zero-detect/overflow) | IRQ14 | FFDEн | FFDF ${ }_{\text {H }}$ | L14 [1:0] |  |
| 16-bit PPG | IRQ15 | FFDC ${ }_{\text {H }}$ | FFDD ${ }_{\text {н }}$ | L15 [1:0] |  |
| $1^{2} \mathrm{C}$ | IRQ16 | FFDA | FFDB | L16 [1:0] |  |
| - | IRQ17 | FFD8 ${ }^{\text {¢ }}$ | FFD9н | L17 [1:0] |  |
| 8/10-bit A/D converter | IRQ18 | FFD6 | FFD7н | L18 [1:0] |  |
| Time-base timer | IRQ19 | FFD4н | FFD5 | L19 [1:0] |  |
| Watch prescaler | IRQ20 | FFD2 ${ }_{\text {н }}$ | FFD3 ${ }_{\text {¢ }}$ | L20 [1:0] |  |
| - | IRQ21 | FFDOH | FFD1н | L21 [1:0] |  |
| - | IRQ22 | FFCE, | FFCF | L22 [1:0] | $\nabla$ |
| Flash memory | IRQ23 | FFCCH | FFCD ${ }_{\text {н }}$ | L23 [1:0] | Low |

## ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Ratings

| Parameter | Symbol | Rating |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max |  |  |
| Power supply voltage*1 | Vcc | Vss - 0.3 | Vss + 6 | V |  |
| Input voltage*1 | V | Vss - 0.3 | Vss +6 | V | *2 |
| Output voltage*1 | Vo | Vss - 0.3 | Vss + 6 | V | *2 |
| Maximum clamp current | Iclamp | -2 | +2 | mA | Applicable to specific pins*3 |
| Total maximum clamp current | $\Sigma \mathrm{llclampl}$ | - | 20 | mA | Applicable to specific pins*3 |
| " L " level maximum output current | loL1 | - | 15 | mA | Other than P05 and P06 |
|  | lol2 |  | 15 |  | P05 and P06 |
| "L" level average current | lolav1 | - | 4 | mA | Other than P05 and P06 Average output current $=$ operating current $\times$ operating ratio (1 pin) |
|  | lolav2 | - | 12 |  | P05 and P06 <br> Average output current $=$ operating current $\times$ operating ratio (1 pin) |
| "L" level total maximum output current | $\Sigma \mathrm{lob}$ | - | 100 | mA |  |
| "L" level total average output current | $\Sigma$ Iolav | - | 50 | mA | Total average output current = operating current $\times$ operating ratio (Total number of pins) |
| "H" level maximum output current | Іон1 | - | -15 | mA | Other than P05 and P06 |
|  | Іон2 | - | -15 |  | P05 and P06 |
| " H " level average current | Іohav1 | - | -4 | mA | Other than P05 and P06 Average output current $=$ operating current $\times$ operating ratio (1 pin) |
|  | Іohav2 | - | -8 |  | P05 and P06 <br> Average output current $=$ operating current $\times$ operating ratio (1 pin) |
| "H" level total maximum output current | $\Sigma$ lon | - | -100 | mA |  |
| "H" level total average output current | $\Sigma$ Iohav | - | -50 | mA | Total average output current = operating current $\times$ operating ratio (Total number of pins) |
| Power consumption | Pd | - | 320 | mW |  |
| Operating temperature | TA | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |  |
| Storage temperature | Tstg | -55 | +150 | ${ }^{\circ} \mathrm{C}$ |  |

(Continued)

## (Continued)

*1: The parameter is based on $\mathrm{Vss}=0.0 \mathrm{~V}$.
*2: $\mathrm{V}_{1}$ and $\mathrm{V}_{0}$ must not exceed $\mathrm{V} c \mathrm{c}+0.3 \mathrm{~V}$. $\mathrm{V}_{1}$ must not exceed the rated voltage. However, if the maximum current to/from an input is limited by means of an external component, the Iclamp rating is used instead of the $\mathrm{V}_{1}$ rating.
*3: Applicable to the following pins: P00 to P07, P60 to P67, P70 to P76, PF0 and PF1

- Use under recommended operating conditions.
- Use with DC voltage (current).
- The HV (High Voltage) signal is an input signal exceeding the Vcc voltage. Always connect a limiting resistor between the HV (High Voltage) signal and the microcontroller before applying the HV (High Voltage) signal.
- The value of the limiting resistor should be set to a value at which the current to be input to the microcontroller pin when the HV (High Voltage) signal is input is below the standard value, irrespective of whether the current is transient current or stationary current.
- When the microcontroller drive current is low, such as in low power consumption modes, the HV (High Voltage) input potential may pass through the protective diode to increase the potential of the Vcc pin, affecting other devices.
- If the HV (High Voltage) signal is input when the microcontroller power supply is off (not fixed at 0 V ), since power is supplied from the pins, incomplete operations may be executed.
- If the HV (High Voltage) input is input after power-on, since power is supplied from the pins, the voltage of power supply may not be sufficient to enable a power-on reset.
- Do not leave the HV (High Voltage) input pin unconnected.
- Example of a recommended circuit
- Input/Output equivalent circuit


WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

## 2. Recommended Operating Conditions

$(\mathrm{V} s \mathrm{~s}=0.0 \mathrm{~V})$

| Parameter | Symbol | Value |  | Unit | Remarks |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max |  |  |  |
| Power supply voltage | Vcc | $2.4{ }^{\star 1 * 2}$ | 5.5*1 | V | In normal operation | Other than on-chip debug mode |
|  |  | 2.3 | 5.5 |  | Hold condition in stop mode |  |
|  |  | 2.9 | 5.5 |  | In normal operation | On-chip debug mode |
|  |  | 2.3 | 5.5 |  | Hold condition in stop mode |  |
| Smoothing capacitor | Cs | 0.022 | 1 | $\mu \mathrm{F}$ | *3 |  |
| Operating | TA | -40 | +85 | ${ }^{\circ} \mathrm{C}$ | Other than on-chip debug mode |  |
| temperature |  | +5 | +35 |  | On-chip debug mode |  |

*1: The value varies depending on the operating frequency, the machine clock and the analog guaranteed range.
*2: This value becomes 2.88 V when the low-voltage detection reset is used.
*3: Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. The bypass capacitor for the Vcc pin must have a capacitance larger than Cs. For the connection to a smoothing capacitor Cs , see the diagram below. To prevent the device from unintentionally entering an unknown mode due to noise, minimize the distance between the C pin and Cs and the distance between Cs and the V ss pin when designing the layout of a printed circuit board.

- DBG / $\overline{\mathrm{RST}} / \mathrm{C}$ pins connection diagram

*: Since the DBG pin becomes a communication pin in on-chip debug mode, set a pull-up resistor value suiting the input/output specifications of P12/EC0/UI/SCL/DBG.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.
Always use semiconductor devices within their recommended operating condition ranges.
Operation outside these ranges may adversely affect reliability and could result in device failure. No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

## 3. DC Characteristics

$\left(\mathrm{Vcc}=5.0 \mathrm{~V} \pm 10 \%, \mathrm{~V} s \mathrm{~s}=0.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Parameter | Symbol | Pin name | Condition | Value |  |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ ${ }^{\text {² }}$ | Max |  |  |
| "H" level input voltage | Vıн | $\begin{aligned} & \text { P03, P04, P12, } \\ & \text { P65 } \end{aligned}$ | *1 | 0.7 Vcc | - | $\mathrm{Vcc}+0.3$ | V | When CMOS input level (hysteresis input) is selected |
|  | Vihs | $\begin{aligned} & \text { P00 to P07, } \\ & \text { P12, } \\ & \text { P60 to P67, P70 } \\ & \text { to P76, } \\ & \text { PF0, PF1, PG1, } \\ & \text { PG2 } \end{aligned}$ | *1 | 0.8 Vcc | - | $\mathrm{Vcc}+0.3$ | V | Hysteresis input |
|  | Vінм | PF2 | - | 0.7 Vcc | - | $\mathrm{Vcc}+0.3$ | V | Hysteresis input |
| "L" level input voltage | VIL | $\begin{aligned} & \text { P03, P04, P12, } \\ & \text { P65 } \end{aligned}$ | *1 | Vss - 0.3 | - | 0.3 Vcc | V | When CMOS input level (hysteresis input) is selected |
|  | Vils | $\begin{aligned} & \text { P00 to P07, } \\ & \text { P12, } \\ & \text { P60 to P67, P70 } \\ & \text { to P76, } \\ & \text { PF0, PF1, PG1, } \\ & \text { PG2 } \end{aligned}$ | *1 | Vss - 0.3 | - | 0.2 Vcc | V | Hysteresis input |
|  | VILM | PF2 | - | Vss - 0.3 | - | 0.3 Vcc | V | Hysteresis input |
| Open-drain output application voltage | V ${ }_{\text {d }}$ | $\begin{aligned} & \text { P03, P04, P12, } \\ & \text { P65, PF2 } \end{aligned}$ | - | Vss - 0.3 | - | Vss +5.5 | V | P03, P04 and P65 are open-drain output pins when assigned as the SDA/SCL pin of $\mathrm{I}^{2} \mathrm{C}$. |
| "H" level output voltage | Vor1 | Output pins other than P05, P06, P12 and PF2 | $\mathrm{IO}=-4 \mathrm{~mA}$ | V cc-0.5 | - | - | V |  |
|  | Voh2 | P05, P06 | $\mathrm{IOH}=-8 \mathrm{~mA}$ | V cc-0.5 | - | - | V |  |
| "L" level output voltage | Vol1 | Output pins other than P05 and P06 | $\mathrm{loL}=4 \mathrm{~mA}$ | - | - | 0.4 | V |  |
|  | Vol2 | P05, P06 | $\mathrm{loL}=12 \mathrm{~mA}$ | - | - | 0.4 | V |  |
| Input leak current (Hi-Z output leak current) | ILı | All input pins | $0.0 \mathrm{~V}<\mathrm{V}_{1}<\mathrm{V}_{\mathrm{cc}}$ | -5 | - | +5 | $\mu \mathrm{A}$ | When pull-up resistance is disabled |
| Pull-up resistance | Rpull | $\begin{aligned} & \text { P00 to P07, } \\ & \text { PG1, PG2 } \end{aligned}$ | $\mathrm{V}_{1}=0 \mathrm{~V}$ | 25 | 50 | 100 | $\mathrm{k} \Omega$ | When pull-up resistance is enabled |
| Input capacitance | Cin | Other than Vcc and Vss | $\mathrm{f}=1 \mathrm{MHz}$ | - | 5 | 15 | pF |  |

(Continued)

| Parameter | Symbol | Pin name | Condition | Value |  |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ ${ }^{\text {3 }}$ | Max |  |  |
| Power supply current ${ }^{* 2}$ | Icc | $V_{c c}$ <br> (External clock operation) | $\begin{aligned} & V_{\mathrm{CC}}=5.5 \mathrm{~V} \\ & \mathrm{~F}_{\mathrm{CH}}=32 \mathrm{MHz} \\ & \mathrm{~F}_{\mathrm{MP}}=16 \mathrm{MHz} \\ & \text { Main clock mode } \\ & \text { (divided by 2) } \end{aligned}$ | - | 12.1 | 22 | mA | Flash memory product (except writing and erasing) |
|  |  |  |  | - | 39.3 | 46.8 | mA | Flash memory product (at writing and erasing) |
|  |  |  |  | - | 13.8 | 30.3 | mA | At A/D conversion |
|  |  |  |  | - | 12.5 | 23.4 | mA | When the voltage comparator is operating |
|  |  |  |  | - | 13.4 | 22.3 | mA | When the OPAMP is operating |
|  | Iccs |  | $\begin{array}{\|l} \hline V_{c c}=5.5 \mathrm{~V} \\ F_{c \mathrm{cH}}=32 \mathrm{MHz} \\ \mathrm{~F}_{\mathrm{MP}}=16 \mathrm{MHz} \\ \text { Main sleep mode } \\ \text { (divided by 2) } \end{array}$ | - | 5.1 | 13.2 | mA |  |
|  | Iccı |  | $\begin{aligned} & \hline \mathrm{VcC}=5.5 \mathrm{~V} \\ & \mathrm{Fccm}_{\mathrm{cc}}=32 \mathrm{kHz} \\ & \mathrm{~F}_{\mathrm{MPL}}=16 \mathrm{kHz} \\ & \text { Subclock mode } \\ & \text { (divided by 2) } \\ & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \end{aligned}$ | - | 57 | 168 | $\mu \mathrm{A}$ |  |
|  | Iccıs |  | $\begin{aligned} & \hline \mathrm{VCC}=5.5 \mathrm{~V} \\ & \mathrm{FCL}=32 \mathrm{kHz} \\ & \mathrm{~F}_{\text {MPL }}=16 \mathrm{kHz} \\ & \text { Subsleep mode } \\ & \text { (divided by 2) } \\ & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \end{aligned}$ | - | 7.6 | 92 | $\mu \mathrm{A}$ |  |
|  | Ісст |  | $\begin{aligned} & \mathrm{V} \mathrm{VC}=5.5 \mathrm{~V} \\ & \mathrm{FCL}^{2}=32 \mathrm{kHz} \\ & \text { Watch mode } \\ & \text { Main stop mode } \\ & \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C} \end{aligned}$ | - | 4.2 | 33 | $\mu \mathrm{A}$ |  |
|  | Iccmcr |  | $\begin{array}{\|l\|} \hline V_{C C}=5.5 \mathrm{~V} \\ F_{C R H}=12.5 \mathrm{MHz} \\ \text { FMP }^{\mathrm{MP}} 12.5 \mathrm{MHz} \\ \text { Main CR clock mode } \end{array}$ | - | 9.6 | 18.2 | mA |  |
|  | Iccscr |  | $\begin{array}{\|l} V_{C C}=5.5 \mathrm{~V} \\ \text { Sub-CR clock mode } \\ \text { (divided by 2) } \\ T_{\mathrm{A}}=+25^{\circ} \mathrm{C} \end{array}$ | - | 107.4 | 550 | $\mu \mathrm{A}$ |  |

(Continued)
(Continued)
$\left(\mathrm{Vcc}=5.0 \mathrm{~V} \pm 10 \%, \mathrm{~V} s \mathrm{~s}=0.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Parameter | Symbol | Pin name | Condition | Value |  |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ ${ }^{\text {* }}$ | Max |  |  |
| Power supply current*2 | Iccts | Vcc <br> (External clock operation) | $\begin{aligned} & \mathrm{V}_{\mathrm{cc}}=5.5 \mathrm{~V} \\ & \mathrm{~F}_{\mathrm{cH}}=32 \mathrm{MHz} \end{aligned}$ <br> Time-base timer mode $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | - | 0.9 | 3.3 | mA |  |
|  | Іссн |  | $\mathrm{V}_{\mathrm{cc}}=5.5 \mathrm{~V}$ Substop mode $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ | - | 3.5 | 24.8 | $\mu \mathrm{A}$ |  |
|  | ILvD | Vcc | Current consumption for low-voltage detection circuit only | - | 26.9 | 54 | $\mu \mathrm{A}$ |  |
|  | Icri |  | Current consumption for the main CR oscillator | - | 0.2 | 0.6 | mA |  |
|  | Icrl |  | Current consumption for the sub-CR oscillator oscillating at 100 kHz | - | 64.7 | 72 | $\mu \mathrm{A}$ |  |

*1: The input levels of P04 can be switched between "CMOS input level" and "hysteresis input level". The input level selection register (ILSR) is used to switch between the two input levels.
*2: • The power supply current is determined by the external clock. When the low-voltage detection option is selected, the power-supply current will be the sum of adding the current consumption of the low-voltage detection circuit (lıvo) to one of the value from Icc to Icch. In addition, when both the low-voltage detection option and the CR oscillator are selected, the power supply current will be the sum of adding up the current consumption of the low-voltage detection circuit, the current consumption of the CR oscillators (Icra, Icrl) and a specified value. In on-chip debug mode, the CR oscillator (IcRH) and the low-voltage detection circuit are always enabled, and current consumption therefore increases accordingly.

- See "4. AC Characteristics: (1) Clock Timing" for Fch $_{\text {ch }}$ Fcl.
- See "4. AC Characteristics: (2) Source Clock/Machine Clock" for Fmp and Fmpl.
*3: $\mathrm{Vcc}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$


## 4. AC Characteristics

(1) Clock Timing
( $\mathrm{Vcc}=2.4 \mathrm{~V}$ to 5.5 V , V ss $=0.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ )

| Parameter | Symbol | Pin name | Condition | Value |  |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max |  |  |
| Clock frequency | Fch | X0, X1 | - | 1 | - | 16.25 | MHz | When the main oscillation circuit is used |
|  |  | X0 | X1: open | 1 | - | 12 | MHz | When the main external clock is used |
|  |  | X0, X1 | * | 1 | - | 32.5 | MHz |  |
|  | Fcrat | - | - | TBD | 12.5 | TBD | MHz | When the main CR clock is used |
|  |  |  |  | TBD | 10 | TBD | MHz |  |
|  |  |  |  | TBD | 8 | TBD | MHz |  |
|  |  |  |  | TBD | 1 | TBD | MHz |  |
|  | Fcı | X0A, X1A | - | - | 32.768 | - | kHz | When the sub-oscillation circuit is used |
|  |  |  |  | - | 32.768 | - | kHz | When the sub-external clock is used |
|  | Fcrl | - | - | 50 | 100 | 200 | kHz | When the sub-CR clock is used |
| Clock cycle time | thcyl | X0, X1 | - | 61.5 | - | 1000 | ns | When the main oscillation circuit is used |
|  |  | X0 | X1: open | 83.4 | - | 1000 | ns | When the external clock is used |
|  |  | X0, X1 | * | 30.8 | - | 1000 | ns |  |
|  | tıcy | X0A, X1A | - | - | 30.5 | - | $\mu \mathrm{s}$ | When the subclock is used |
| Input clock pulse width | $\begin{aligned} & \text { twh1 } \\ & \text { twL1 } \end{aligned}$ | X0 | X1: open | 33.4 | - | - | ns | When the external clock is used, the duty ratio should range between $40 \%$ and $60 \%$. |
|  |  | X0, X1 | * | 12.4 | - | - | ns |  |
|  | $\begin{aligned} & \text { twh2 } \\ & \text { twL2 } \end{aligned}$ | XOA | - | - | 15.2 | - | $\mu \mathrm{s}$ |  |
| Input clock rise time and fall time | $\begin{aligned} & \text { tcR } \\ & \text { tcF } \end{aligned}$ | X0 | X1: open | - | - | 5 | ns | When the external clock is used |
|  |  | X0, X1 | * | - | - | 5 | ns |  |
| CR oscillation start time | tс尺ннк | - | - | - | - | 80 | $\mu \mathrm{s}$ | When the main CR clock is used |
|  | tcrıwk | - | - | - | - | 10 | $\mu \mathrm{s}$ | When the sub-CR clock is used |

*: The external clock signal is input to $\mathrm{X0}$ and the inverted external clock signal to X .


- Figure of main clock input port external connection

When a crystal oscillator or When the external clock is used When the external clock
a ceramic oscillator is used

is used


XOA

- Figure of subclock input port external connection

When a crystal oscillator or a ceramic oscillator is used


When the external clock
is used

(2) Source Clock/Machine Clock
$\left(\mathrm{Vcc}=5.0 \mathrm{~V} \pm 10 \%\right.$, $\mathrm{V} \mathrm{ss}=0.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Parameter | Symbol | Pin name | Value |  |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min | Typ | Max |  |  |
| Source clock cycle time*1 | tsclk | - | 61.5 | - | 2000 | ns | When the main external clock is used Min: $\mathrm{F}_{\mathrm{ch}}=32.5 \mathrm{MHz}$, divided by 2 Max: $\mathrm{F}_{\mathrm{CH}}=1 \mathrm{MHz}$, divided by 2 |
|  |  |  | 80 | - | 1000 | ns | When the main CR clock is used Min: $\mathrm{F}_{\mathrm{CRH}}=12.5 \mathrm{MHz}$ <br> Max: $F_{\text {CRH }}=1 \mathrm{MHz}$ |
|  |  |  | - | 61 | - | $\mu \mathrm{s}$ | When the sub-oscillation clock is used $\mathrm{F}_{\mathrm{CL}}=32.768 \mathrm{kHz}$, divided by 2 |
|  |  |  | - | 20 | - | $\mu \mathrm{s}$ | When the sub-CR clock is used $F_{\text {CRL }}=100 \mathrm{kHz}$, divided by 2 |
| Source clock frequency | Fsp | - | 0.5 | - | 16.25 | MHz | When the main oscillation clock is used |
|  |  |  | 1 | - | 12.5 | MHz | When the main CR clock is used |
|  | FspL |  | - | 16.384 | - | kHz | When the sub-oscillation clock is used |
|  |  |  | - | 50 | - | kHz | When the sub-CR clock is used $F_{C R L}=100 \mathrm{kHz}$, divided by 2 |
| Machine clock cycle time*2 (minimum instruction execution time) | tmCLK | - | 61.5 | - | 32000 | ns | When the main oscillation clock is used <br> Min: $\mathrm{Fsp}_{\text {sp }}=16.25 \mathrm{MHz}$, no division <br> Max: Fsp $=0.5 \mathrm{MHz}$, divided by 16 |
|  |  |  | 80 | - | 16000 | ns | When the main CR clock is used <br> Min: Fsp $=12.5 \mathrm{MHz}$ <br> Max: Fsp $=1 \mathrm{MHz}$, divided by 16 |
|  |  |  | 61 | - | 976.5 | $\mu \mathrm{s}$ | When the sub-oscillation clock is used Min: Fspl $=16.384 \mathrm{kHz}$, no division Max: FspL $=16.384 \mathrm{kHz}$, divided by 16 |
|  |  |  | 20 | - | 320 | $\mu \mathrm{s}$ | When the sub-CR clock is used Min: Fspl $=50 \mathrm{kHz}$, no division Max: FspL $=50 \mathrm{kHz}$, divided by 16 |
| Machine clock frequency | $\mathrm{F}_{\text {MP }}$ | - | 0.031 | - | 16.25 | MHz | When the main oscillation clock is used |
|  |  |  | 0.0625 | - | 12.5 | MHz | When the main CR clock is used |
|  | FMPL |  | 1.024 | - | 16.384 | kHz | When the sub-oscillation clock is used |
|  |  |  | 3.125 | - | 50 | kHz | When the sub-CR clock is used $F_{\text {CRL }}=100 \mathrm{kHz}$ |

*1: This is the clock before it is divided according to the division ratio set by the machine clock divide ratio select bits (SYCC:DIV1 and DIV0). This source clock is divided to become a machine clock according to the divide ratio set by the machine clock divide ratio select bits (SYCC:DIV1 and DIV0). In addition, a source clock can be selected from the following.

- Main clock divided by 2
- Main CR clock
- Subclock divided by 2
- Sub-CR clock divided by 2
*2: This is the operating clock of the microcontroller. A machine clock can be selected from the following.
- Source clock (no division)
- Source clock divided by 4
- Source clock divided by 8
- Source clock divided by 16
- Schematic diagram of the clock generation block

- Operating voltage - Operating frequency (When $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ) MB95430H (without the on-chip debug function)

- Operating voltage - Operating frequency (When $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ ) MB95430H (with the on-chip debug function)

(3) External Reset
$\left(\mathrm{V} \mathrm{cc}=5.0 \mathrm{~V} \pm 10 \%, \mathrm{~V}_{\mathrm{ss}}=0.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Parameter | Symbol | Value |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Max |  |  |
| $\overline{R S T}$ " $L$ " level pulse width | $t_{\text {RStL }}$ | 2 tmcLk*1 | - | ns | In normal operation |
|  |  | Oscillation time of the oscillator*2 +100 | - | $\mu \mathrm{s}$ | In stop mode, subclock mode, subsleep mode, watch mode, and power-on |
|  |  | 100 | - | $\mu \mathrm{s}$ | In time-base timer mode |

*1: See "(2) Source Clock/Machine Clock" for tmclк.
*2: The oscillation time of an oscillator is the time for it to reach $90 \%$ of its amplitude. The crystal oscillator has an oscillation time of between several ms and tens of ms . The ceramic oscillator has an oscillation time of between hundreds of $\mu \mathrm{s}$ and several ms . The external clock has an oscillation time of 0 ms . The CR oscillator clock has an oscillation time of between several $\mu$ s and several ms .

- In normal operation
$\overline{\mathrm{RST}}$

- In stop mode, subclock mode, subsleep mode, watch mode and power-on

(4) Power-on Reset

| Parameter | Symbol | Condition | $\left(\mathrm{V} s \mathrm{ss}=0.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$ |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Value |  | Unit | Remarks |
|  |  |  | Min | Max |  |  |
| Power supply rising time | $t_{R}$ | - | - | 50 | ms |  |
| Power supply cutoff time | toff | - | 1 | - | ms | Wait time until power-on |



Note: A sudden change of power supply voltage may activate the power-on reset function. When changing the power supply voltage during the operation, set the slope of rising to a value below within $30 \mathrm{mV} / \mathrm{ms}$ as shown below.

(5) Peripheral Input Timing

| $\left(\mathrm{Vcc}=5.0 \mathrm{~V} \pm 10 \%\right.$, $\mathrm{Vss}=0.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $\left.+85^{\circ} \mathrm{C}\right)$ |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter | Symbol | Pin name | Value |  | Unit |
|  |  |  | Min | Max |  |
| Peripheral input "H" pulse width | tııı | INT00 to INT07, EC0, ADTG, TRG | 2 tмськ* | - | ns |
| Peripheral input "L" pulse width | tiHIL |  | 2 тмськ* | - | ns |

*: See "(2) Source Clock/Machine Clock" for tmalк.

INT00 to INT07, EC0, ADTG, TRG


 0.2 Vcc
(6) UART/SIO, Serial I/O Timing
$\left(\mathrm{Vcc}=5.0 \mathrm{~V} \pm 10 \%, \mathrm{AV}\right.$ ss $=\mathrm{Vss}=0.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Parameter | Symbol | Pin name | Condition | Value |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Max |  |
| Serial clock cycle time | tscyc | UCK | Internal clock operation | 4 tmalk* | - | ns |
| UCK $\downarrow \rightarrow$ UO time | tslov | UCK, UO |  | -190 | +190 | ns |
| Valid UI $\rightarrow$ UCK $\uparrow$ | tivsh | UCK, UI |  | 2 tmack* | - | ns |
| UCK $\uparrow \rightarrow$ valid UI hold time | tshix | UCK, UI |  | 2 tmack* | - | ns |
| Serial clock "H" pulse width | tshSL | UCK | External clock operation | 4 tmack* | - | ns |
| Serial clock "L" pulse width | tsLSH | UCK |  | 4 tmack* | - | ns |
| UCK $\downarrow \rightarrow$ UO time | tsLov | UCK, UO |  | - | 190 | ns |
| Valid UI $\rightarrow$ UCK $\uparrow$ | tivsh | UCK, UI |  | 2 tmack* | - | ns |
| UCK $\uparrow \rightarrow$ valid UI hold time | tshix | UCK, UI |  | 2 tmack* | - | ns |

*: See "(2) Source Clock/Machine Clock" for tmalk.

- Internal shift clock mode

- External shift clock mode



## (7) Low-voltage Detection

(Vss $=0.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Parameter | Symbol | Value |  |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max |  |  |
| Release voltage | VDL+ | 2.52 | 2.7 | 2.88 | V | At power supply rise |
| Detection voltage | V DL - | 2.42 | 2.6 | 2.78 | V | At power supply fall |
| Hysteresis width | Vhys | 70 | 100 | - | mV |  |
| Power supply start voltage | $\mathrm{V}_{\text {off }}$ | - | - | 2.3 | V |  |
| Power supply end voltage | Von | 4.9 | - | - | V |  |
| Power supply voltage change time <br> (at power supply rise) | tr | 3000 | - | - | $\mu \mathrm{s}$ | Slope of power supply that the reset release signal generates within the rating (VDL+) |
| Power supply voltage change time (at power supply fall) | $\mathrm{tf}^{\text {f}}$ | 300 | - | - | $\mu \mathrm{s}$ | Slope of power supply that the reset detection signal generates within the rating (VdL-) |
| Reset release delay time | $\mathrm{t}_{\mathrm{d} 1}$ | - | - | 300 | $\mu \mathrm{s}$ |  |
| Reset detection delay time | td2 | - | - | 20 | $\mu \mathrm{s}$ |  |


(8) $\mathrm{I}^{2} \mathrm{C}$ Timing

| $\left(\mathrm{Vcc}=5.0 \mathrm{~V} \pm 10 \%, \mathrm{AV}\right.$ ss $=\mathrm{V}_{\text {ss }}=0.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $\left.+85^{\circ} \mathrm{C}\right)$ |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter | Symbol | Pin name | Condition | Value |  |  |  | Unit |
|  |  |  |  | Standardmode |  | Fast-mode |  |  |
|  |  |  |  | Min | Max | Min | Max |  |
| SCL clock frequency | fscl | SCL | $\begin{aligned} & \mathrm{R}=1.7 \mathrm{k} \Omega, \\ & \mathrm{C}=50 \mathrm{pF}^{* 1} \end{aligned}$ | 0 | 100 | 0 | 400 | kHz |
| (Repeated) START condition hold time SDA $\downarrow \rightarrow$ SCL $\downarrow$ | thd; Sta | SCL, SDA |  | 4.0 | - | 0.6 | - | $\mu \mathrm{s}$ |
| SCL clock "L" width | tıow | SCL |  | 4.7 | - | 1.3 | - | $\mu \mathrm{s}$ |
| SCL clock "H" width | thigh | SCL |  | 4.0 | - | 0.6 | - | $\mu \mathrm{s}$ |
| (Repeated) START condition hold time SCL $\uparrow \rightarrow$ SDA $\downarrow$ | tsu;STA | SCL, SDA |  | 4.7 | - | 0.6 | - | $\mu \mathrm{s}$ |
| Data hold time $\text { SCL } \downarrow \rightarrow \text { SDA } \downarrow \uparrow$ | thd;DAT | SCL, SDA |  | 0 | $3.45^{*}$ | 0 | $0.9{ }^{*}$ | $\mu \mathrm{s}$ |
| Data setup time SDA $\downarrow \uparrow \rightarrow$ SCL $\uparrow$ | tsu;DAT | SCL, SDA |  | 0.25 | - | 0.1 | - | $\mu \mathrm{s}$ |
| STOP condition setup time SCL $\uparrow \rightarrow$ SDA $\uparrow$ | tsu;sto | SCL, SDA |  | 4 | - | 0.6 | - | $\mu \mathrm{s}$ |
| Bus free time between STOP condition and START condition | tbuf | SCL, SDA |  | 4.7 | - | 1.3 | - | $\mu \mathrm{s}$ |

*1: R represents the pull-up resistor of the SCL and SDA lines, and C the load capacitor of the SCL and SDA lines.
*2: The maximum thd;дат in the Standard-mode is applicable only when the time during which the device is holding the SCL signal at "L" (tıow) does not extend.
*3: A Fast-mode $I^{2} \mathrm{C}$-bus device can be used in a Standard-mode $\mathrm{I}^{2} \mathrm{C}$-bus system, provided that the condition of tsu;DAT $\geq 250 \mathrm{~ns}$ is fulfilled.

(Continued)
$\left(\mathrm{V} \mathrm{cc}=5.0 \mathrm{~V} \pm 10 \%, \mathrm{AV} \mathrm{Ss}=\mathrm{V} \mathrm{ss}=0.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Parameter | $\begin{aligned} & \text { Sym- } \\ & \text { bol } \end{aligned}$ | Pin name | Condition | Value*2 |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Max |  |  |
| SCL clock "L" width | tıow | SCL | $\begin{aligned} & \mathrm{R}=1.7 \mathrm{k} \Omega, \\ & \mathrm{C}=50 \mathrm{pF}^{* 1} \end{aligned}$ | ( $2+\mathrm{nm} / 2$ ) $\mathrm{tmcLk}-20$ | - | ns | Master mode |
| SCL clock "H" width | thigh | SCL |  | ( $\mathrm{nm} / 2$ ) tmalk - $20^{\text {a }}$ | ( $\mathrm{nm} / 2$ ) tmalk $^{\text {+ }} 20$ | ns | Master mode |
| START conditionhold time | thd; Sta | $\begin{aligned} & \text { SCL, } \\ & \text { SDA } \end{aligned}$ |  | $(-1+n m / 2)$ tmcLk -20 | $(-1+n m)$ tmclk $^{+} 20$ | ns | Master mode Maximum value is applied when $m, n=1,8$. Otherwise, the minimum value is applied. |
| STOP condition setup time | tsu;sto | $\begin{aligned} & \text { SCL, } \\ & \text { SDA } \end{aligned}$ |  | $(1+n m / 2)$ tmclk -20 | $(1+n m / 2)$ tmclk +20 | ns | Master mode |
| START condition setup time | tsu;sta | $\begin{aligned} & \text { SCL, } \\ & \text { SDA } \end{aligned}$ |  | $(1+n m / 2)$ tmclk -20 | $(1+n m / 2)$ tmcle $^{+} 20$ | ns | Master mode |
| Bus free time between STOP condition and START condition | tbuf | $\begin{aligned} & \text { SCL, } \\ & \text { SDA } \end{aligned}$ |  | $(2 \mathrm{~nm}+4)$ tmclk -20 | - | ns |  |
| Data hold time | thd;Dat | $\begin{aligned} & \text { SCL, } \\ & \text { SDA } \end{aligned}$ |  | 3 tmсlк - 20 | - | ns | Master mode |
| Data setup time | tsu;DAt | $\begin{aligned} & \text { SCL, } \\ & \text { SDA } \end{aligned}$ |  | $(-2+n m / 2)$ tmclk -20 | $(-1+n m / 2)$ tмськ +20 | ns | Master mode When assuming that " $L$ " of SCL is not extended, the minimum value is applied to first bit of continuous data. Otherwise, the maximum value is applied. |
| Setup time between clearing interrupt and SCL rising | tsu;int | SCL |  | ( $\mathrm{nm} / 2$ ) tmalk - 20 | $(1+n m / 2)$ tmclk +20 | ns | Minimum value is applied to interrupt at 9th SCL $\downarrow$. Maximum value is applied to the interrupt at the 8th SCL $\downarrow$. |

(Continued)
(Continued)
$\left(\mathrm{V} \mathrm{cc}=5.0 \mathrm{~V} \pm 10 \%, \mathrm{AV} \mathrm{ss}=\mathrm{V} s \mathrm{ss}=0.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}\right.$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Parameter | Symbol | Pin name | Condition | Value*2 |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Max |  |  |
| SCL clock "L" width | tıow | SCL | $\begin{aligned} & \mathrm{R}=1.7 \mathrm{k} \Omega, \\ & \mathrm{C}=50 \mathrm{pF}^{* 1} \end{aligned}$ | 4 tmсlк - 20 | - | ns | At reception |
| SCL clock "H" width | thigh | SCL |  | 4 tmсlк - 20 | - | ns | At reception |
| START condition detection | thd; STA | $\begin{aligned} & \text { SCL, } \\ & \text { SDA } \end{aligned}$ |  | 2 tmclk - 20 | - | ns | Undetected when 1 tmсLк is used at reception |
| STOP condition detection | tsu;sto | $\begin{aligned} & \text { SCL, } \\ & \text { SDA } \end{aligned}$ |  | 2 tmсlк - 20 | - | ns | Undetected when 1 tmсlк is used at reception |
| RESTART condition detection condition | tsu;sta | $\begin{aligned} & \text { SCL, } \\ & \text { SDA } \end{aligned}$ |  | 2 tmсlк - 20 | - | ns | Undetected when 1 tmсlк is used at reception |
| Bus free time | tbuf | $\begin{aligned} & \text { SCL, } \\ & \text { SDA } \end{aligned}$ |  | 2 tmсlк - 20 | - | ns | At reception |
| Data hold time | thd; ${ }_{\text {dAt }}$ | $\begin{aligned} & \text { SCL, } \\ & \text { SDA } \end{aligned}$ |  | 2 tmсlк - 20 | - | ns | At slave transmission mode |
| Data setup time | tsu;dat | $\begin{aligned} & \text { SCL, } \\ & \text { SDA } \end{aligned}$ |  | tıow - 3 tmcle - 20 | - | ns | At slave transmission mode |
| Data hold time | thd;dat | $\begin{aligned} & \text { SCL, } \\ & \text { SDA } \end{aligned}$ |  | 0 | - | ns | At reception |
| Data setup time | tsu;dat | $\begin{aligned} & \text { SCL, } \\ & \text { SDA } \end{aligned}$ |  | tmalk - 20 | - | ns | At reception |
| SDA $\downarrow \rightarrow$ SCL $\uparrow$ <br> (at wakeup function) | twakeup | $\begin{aligned} & \text { SCL, } \\ & \text { SDA } \end{aligned}$ |  | Oscillation stabilization wait time +2 tмсlк - 20 | - | ns |  |

*1: R represents the pull-up resistor of the SCL and SDA lines, and C the load capacitor of the SCL and SDA lines.
*2: • See "(2) Source Clock/Machine Clock" for tmсlк.

- m represents the CS4 bit and CS3 bit (bit 4 and bit 3) in the ${ }^{2} \mathrm{C}$ clock control register (ICCRO).
- n represents the CS2 bit to CS0 bit (bit 2 to bit 0 ) in the $\mathrm{I}^{2} \mathrm{C}$ clock control register (ICCR0).
- The actual timing of $I^{2} \mathrm{C}$ is determined by the values of m and n set by the machine clock (tmclк) and the CS4 to CS0 bits in the ICCR0 register.
- Standard-mode:
m and n can be set to values in the following range: $0.9 \mathrm{MHz}<\mathrm{t}_{\text {мськ }}$ (machine clock) < 10 MHz .
The usable frequencies of the machine clock are determined by the settings of $m$ and $n$ as shown below.
$(m, n)=(1,8)$
$0.9 \mathrm{MHz}<\mathrm{t}_{\text {мсLк }} \leq 1 \mathrm{MHz}$
$(\mathrm{m}, \mathrm{n})=(1,22),(5,4),(6,4),(7,4),(8,4) \quad: 0.9 \mathrm{MHz}<$ tмськ $^{5} 2 \mathrm{MHz}$
$(\mathrm{m}, \mathrm{n})=(1,38),(5,8),(6,8),(7,8),(8,8) \quad: 0.9 \mathrm{MHz}<$ tмськ $^{5} 4 \mathrm{MHz}$
$(m, n)=(1,98) \quad: 0.9 \mathrm{MHz}<$ tmclk $^{5} \leq 10 \mathrm{MHz}$
- Fast-mode:
m and n can be set to values in the following range: $3.3 \mathrm{MHz}<$ tмськ (machine clock) $<10 \mathrm{MHz}$.
The usable frequencies of the machine clock are determined by the settings of $m$ and $n$ as shown below.

| $(\mathrm{m}, \mathrm{n})=(1,8)$ | : $3.3 \mathrm{MHz}<\mathrm{tmCLK}^{5} 4 \mathrm{MHz}$ |
| :---: | :---: |
| $(\mathrm{m}, \mathrm{n})=(1,22),(5,4)$ | : $3.3 \mathrm{MHz}<\mathrm{tmcLk}^{5} 8 \mathrm{MHz}$ |
| $(\mathrm{m}, \mathrm{n})=(6,4)$ | : $3.3 \mathrm{MHz}<\mathrm{t}_{\text {mсıк }} \leq 10 \mathrm{MHz}$ |

(9) Voltage Compare Timing

| Parameter | Pin name | Value |  |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max |  |  |
| Voltage range | CMPn_P, <br> CMPn_N $(n=0,1,2,3)$ | 0 | - | Vcc-1.3 | V |  |
| Offset voltage | CMPn_P, <br> CMPn_N $(\mathrm{n}=0,1,2,3)$ | -10 | - | +10 | mV |  |
| Delay time | $\begin{aligned} & \text { CMPn_O } \\ & (\mathrm{n}=0,1,2,3) \end{aligned}$ | - | 650 | 1210 | ns | 5 mV overdrive |
|  |  | - | 140 | 420 | ns | 50 mV overdrive |
| Power down delay | CMPn_O$(\mathrm{n}=0,1,2,3)$ | - | - | 1210 | ns | Power down recovery $\text { PD: } 1 \rightarrow 0$ |
|  |  | 0 | - | - | ns | Power down effective <br> PD: $0 \rightarrow 1$ <br> Output: "H" level |
| Power up stabilization time | $\begin{aligned} & \text { CMPn_O } \\ & (\mathrm{n}=0,1,2,3) \end{aligned}$ | - | - | 1210 | ns | Output stabilization time at power up |

## (9) Operational Amplifier Timing

- Open Loop Configuration
$\left(\mathrm{Vcc}=4.0 \mathrm{~V}\right.$ to $5.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Parameter | Pin name | Value |  |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max |  |  |
| Input voltage range | $\begin{aligned} & \text { OPAMP_P, } \\ & \text { OPAMP_N } \end{aligned}$ | 0.1 | - | 1.5 | V |  |
| Output voltage range | OPAMP_O | 0.1 | - | V cc-0.1 | V |  |
| Output resistor load | OPAMP_O | 220k | - | - | ohm | Minimum driving resistor value |
| Output capacitor load | OPAMP_O | - | - | 20 | pF | AD loading (maximum ESR $=10 \mathrm{k}$ ) |
| Offset voltage | OPAMP_O | - | - | 10 | mV |  |
| Open loop bandwidth | OPAMP_O | 3 | - | - | MHz |  |
| Open loop gain | OPAMP_O | 75 | 85 | - | dB | AD loading |
| Common mode rejection ratio | OPAMP_O | 60 | - | - | dB | AD loading |
| Power supply rejection ratio | OPAMP_O | 65 | - | - | dB |  |
| Power down recovery time | OPAMP_O | - | - | 200 | $\mu \mathrm{s}$ |  |
| Slew rate | OPAMP_O | 0.3 | - | - | V/ $/ \mathrm{s}$ |  |
| Large signal response | OPAMP_O | - | - | 6 | $\mu \mathrm{s}$ |  |
| Small signal response | OPAMP_O | - | - | 500 | ns |  |
| Output stabilization time | OPAMP_O | - | - | 60 | $\mu \mathrm{s}$ | After changes in values of RES0-RES2 |

## MB95430H Series

- Closed Loop Configuration
$\left(\mathrm{Vcc}=4.0 \mathrm{~V}\right.$ to $5.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Parameter | Pin name | Value |  |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max |  |  |
| Minimum input voltage range $(10 x, 20 x, 60 x)$ | $\begin{aligned} & \text { OPAMP_P, } \\ & \text { OPAMP_N } \end{aligned}$ | - | 0.07 | 0.09 | V |  |
| Minimum input voltage range (30x, 40x, 50x) | $\begin{aligned} & \text { OPAMP_P, } \\ & \text { OPAMP_N } \end{aligned}$ | - | 0.07 | 0.10 | V |  |
| Maximum input voltage range (10x, 20x, 30x, 40x, 50x, 60x) | $\begin{aligned} & \text { OPAMP_P, } \\ & \text { OPAMP_N } \end{aligned}$ | - | - | Vcc/Gain | V |  |
| Output voltage range | OPAMP_O | 0.1 | - | V cc-0.1 | V |  |
| Output capacitor load | OPAMP_O | - | - | 20 | pF | AD loading (maximum ESR = 10k) |
| Closed loop bandwidth | OPAMP_O | 1 | - | - | MHz | AD loading |
| Closed loop gain | OPAMP_O | 10 | - | 60 | V/V | Selectable |
| Closed loop gain error* $(10 x, 20 x, 30 x, 40 x, 50 x)$ | OPAMP_O | - | - | $\pm 10 \%$ | - |  |
| Closed loop gain error* (60x) | OPAMP_O | - | - | $\pm 15 \%$ | - |  |
| Power down recovery time | OPAMP_O | - | - | 200 | $\mu \mathrm{s}$ |  |
| Slew rate | OPAMP_O | 0.3 | - | - | V/ $\mu \mathrm{s}$ |  |
| Large signal response | OPAMP_O | - | - | 6 | $\mu \mathrm{s}$ |  |
| Small signal response | OPAMP_O | - | - | 500 | ns |  |
| Output stabilization time | OPAMP_O | - | - | 60 | $\mu \mathrm{s}$ | After changes in values of RES0-RES2 |

*: Gain error = 1 - (actual gain / design gain)
5. A/D Converter
(1) A/D Converter Electrical Characteristics
$\left(\mathrm{V} \mathrm{cc}=4.0 \mathrm{~V}\right.$ to 5.5 V , V ss $=0.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $\left.+85^{\circ} \mathrm{C}\right)$

| Parameter | Symbol | Value |  |  | Unit | Remarks |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max |  |  |
| Resolution | - | - | - | 10 | bit |  |
| Total error |  | -3 | - | +3 | LSB |  |
| Linearity error |  | -2.5 | - | +2.5 | LSB |  |
| Differential linear error |  | -1.9 | - | +1.9 | LSB |  |
| Zero transition voltage | Vот | Vss - 1.5 LSB | Vss + 0.5 LSB | Vss + 2.5 LSB | V |  |
| Full-scale transition voltage | V ${ }_{\text {fSt }}$ | Vcc - 4.5 LSB | Vcc - 2 LSB | $\mathrm{Vcc}+0.5 \mathrm{LSB}$ | V |  |
| Compare time | - | 0.9 | - | 16500 | $\mu \mathrm{s}$ | $4.5 \mathrm{~V} \leq \mathrm{Vcc} \leq 5.5 \mathrm{~V}$ |
|  |  | 1.8 | - | 16500 | $\mu \mathrm{s}$ | $4.0 \mathrm{~V} \leq \mathrm{Vcc}<4.5 \mathrm{~V}$ |
| Sampling time | - | 0.6 | - | $\infty$ | $\mu \mathrm{s}$ | $\begin{aligned} & 4.5 \mathrm{~V} \leq \mathrm{V} \mathrm{cc} \leq 5.5 \mathrm{~V}, \\ & \text { with external } \\ & \text { impedance }<5.4 \mathrm{k} \Omega \end{aligned}$ |
|  |  | 1.2 | - | $\infty$ | $\mu \mathrm{s}$ | $4.0 \mathrm{~V} \leq \mathrm{Vcc}<4.5 \mathrm{~V}$, with external impedance < $2.4 \mathrm{k} \Omega$ |
| Analog input current | Iain | -0.3 | - | +0.3 | $\mu \mathrm{A}$ |  |
| Analog input voltage | $\mathrm{V}_{\text {AIN }}$ | Vss | - | Vcc | V |  |

## (2) Notes on Using the A/D Converter

- External impedance of analog input and its sampling time
- The A/D converter has a sample and hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the capacitor of the internal sample and hold circuit is insufficient, adversely affecting A/D conversion precision. Therefore, to satisfy the A/D conversion precision standard, considering the relationship between the external impedance and minimum sampling time, either adjust the register value and operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value. In addition, if sufficient sampling time cannot be secured, connect a capacitor of about $0.1 \mu \mathrm{~F}$ to the analog input pin.
- Analog input equivalent circuit


| $\mathbf{V c c}$ | $\mathbf{R}$ | $\mathbf{C}$ |
| :---: | :---: | :---: |
| $4.5 \mathrm{~V} \leq \mathrm{Vcc} \leq 5.5 \mathrm{~V}$ | $1.95 \mathrm{k} \Omega(\operatorname{Max})$ | $17 \mathrm{pF}(\operatorname{Max})$ |
| $4.0 \mathrm{~V} \leq \mathrm{Vcc}<4.5 \mathrm{~V}$ | $8.98 \mathrm{k} \Omega(\operatorname{Max})$ | $17 \mathrm{pF}(\operatorname{Max})$ |

Note: The values are reference values.

- Relationship between external impedance and minimum sampling time


- A/D conversion error

As IVcc-Vssl decreases, the A/D conversion error increases proportionately.

## (3) Definitions of A/D Converter Terms

- Resolution

It indicates the level of analog variation that can be distinguished by the A/D converter.
When the number of bits is 10, analog voltage can be divided into $2^{10}=1024$.

- Linearity error (unit: LSB) It indicates how much an actual conversion value deviates from the straight line connecting the zero transition point ("00 00000000 " $\leftarrow \rightarrow$ "00 00000001 ") of a device to the full-scale transition point ("11 1111 1111" $\leftarrow \rightarrow$ "1111111110") of the same device.
- Differential linear error (unit: LSB) It indicates how much the input voltage required to change the output code by 1 LSB deviates from an ideal value.
- Total error (unit: LSB)

It indicates the difference between an actual value and a theoretical value. The error can be caused by a zero transition error, a full-scale transition errors, a linearity error, a quantum error, or noise.

(Continued)
(Continued)


N : A/D converter digital output value
VNT : Voltage at which the digital output transits from ( $\mathrm{N}-1$ ) H to NH
Vот (ideal value) $=\mathrm{VsS}+0.5 \mathrm{LSB}[\mathrm{V}]$
VFST (ideal value) $=\mathrm{Vcc}-2$ LSB [V]
6. Flash Memory Write/Erase Characteristics

| Parameter | Value |  |  | Unit | Remarks |
| :--- | :---: | :---: | :---: | :---: | :--- |
|  | Min | Typ | Max |  |  |
| Sector erase time <br> (2 Kbyte sector) | - | $0.2^{\star 1}$ | $0.5^{\star 2}$ | s | The time of writing 00H prior to <br> erasure is excluded. |
| Sector erase time <br> (16 Kbyte sector) | - | $0.5^{\star 1}$ | $7.5^{\star 2}$ | s | The time of writing 00H prior to <br> erasure is excluded. |
| Byte writing time | - | 21 | $6100^{\star 2}$ | $\mu \mathrm{~s}$ | System-level overhead is excluded. |
| Erase/write cycle | 100000 | - | - | cycle |  |
| Power supply voltage at erase/ <br> write | 3.0 | - | 5.5 | V |  |
| Flash memory data retention <br> time | $20^{\star 3}$ | - | - | year | Average $\mathrm{T}_{\mathrm{A}}=+85^{\circ} \mathrm{C}$ |

*1: $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}, \mathrm{Vcc}=5.0 \mathrm{~V}, 100000$ cycles
${ }^{*} 2: \mathrm{T}_{\mathrm{A}}=+85^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{Cc}}=3.0 \mathrm{~V}, 100000$ cycles
*3: This value is converted from the result of a technology reliability assessment. (The value is converted from the result of a high temperature accelerated test using the Arrhenius equation with the average temperature being $+85^{\circ} \mathrm{C}$ ).

## MB95430H Series

MASK OPTIONS

| No. | Mart Number | MB95F432H |  |
| :---: | :--- | :--- | :--- |
|  |  |  |  |
|  |  | MB95F434H | MB95F433K |
|  | Selectable/Fixed |  | MB95F434K |
| 1 | Low-voltage detection reset | Without low-voltage detection reset | With low-voltage detection reset |
| 2 | Reset | With dedicated reset input | Without dedicated reset input |

ORDERING INFORMATION

| Part Number | Package |
| :--- | :--- |
| MB95F432HPMC-G-SNE2 |  |
| MB95F432KPMC-G-SNE2 | 32-pin plastic LQFP |
| MB95F433HPMC-G-SNE2 | (FPT-32P-M30) |
| MB95F433KPMC-G-SNE2 |  |
| MB95F434HPMC-G-SNE2 |  |
| MB95F434KPMC-G-SNE2 |  |
| MB95F432HP-G-SH-SNE2 |  |
| MB95F432KP-G-SH-SNE2 | 32-pin plastic SH-DIP |
| MB95F433HP-G-SH-SNE2 | (DIP-32P-M06) |
| MB95F433KP-G-SH-SNE2 |  |
| MB95F434HP-G-SH-SNE2 |  |
| MB95F434KP-G-SH-SNE2 |  |

## PACKAGE DIMENSION

| 32-pin plastic LQFP | Lead pitch | 0.80 mm |
| :---: | :---: | :---: |
| Package width $\times$ <br> package length | $7.00 \mathrm{~mm} \times 7.00 \mathrm{~mm}$ |  |
| Lead shape | Gullwing |  |
| Sealing method | Plastic mold |  |
| Mounting height | 1.60 mm MAX |  |



Please check the latest package dimension at the following URL.
http://edevice.fujitsu.com/package/en-search/
(Continued)
(Continued)

| 32-pin plastic SDIP | Lead pitch | 1.778 mm |
| :--- | :--- | :--- |
|  | Low space | 10.16 mm |
| (DIP-32P-M06) |  | Plastic mold |



Please check the latest package dimension at the following URL. http://edevice.fujitsu.com/package/en-search/

## MB95430H Series

MEMO

MEMO

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